

## C1206F105M3RACTU

Aliases (C1206F105M3RAC7800) SMD Comm X7R FO, Ceramic, 1 uF, 20%, 25 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X7R FO	
Style	SMD Chip	
Description	SMD, MLCC, Open Mode, Temperature Stable	
Features	Open Mode, Temperature Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	25 mg	
Shelf Life	78 Weeks	
MSL	1	

	Specifications	
	Capacitance	1uF
	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	20%
	Voltage DC	25 VDC
	Dielectric Withstanding Voltage	62.5 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
	Dissipation Factor	3.5%1 kHz 1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	500 MOhms

 Dimensions

 Chip Size
 1206

 L
 3.2mm +/-0.2mm

 W
 1.6mm +/-0.2mm

 T
 0.9mm +/-0.20mm

 S
 1.5mm MIN

 B
 0.5mm +/-0.25mm

## Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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